IRF730

Vishay Siliconix



TO-220AB

PRODUCT SUMMARY

V_{DS} (V)

R_{DS(on)} (Ω)

Q_{gs} (nC)

Q_{gd} (nC)

Q_a max. (nC)

Configuration

Power MOSFET

FEATURES

- Dynamic dV/dt rating
- Repetitive avalanche rated
- Fast switching
- Ease of paralleling
- Simple drive requirements
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

Note

S

N-Channel MOSFET

1.0

400

38

5.7

22

Single

 $V_{GS} = 10 V$

* This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

DESCRIPTION

Third generation power MOSFETs from Vishay provide the designer with the best combination of fast switching, ruggedized device design, low on-resistance and cost-effectiveness.

The TO-220AB package is universally preferred for all commercial-industrial applications at power dissipation levels to approximately 50 W. The low thermal resistance and low package cost of the TO-220AB contribute to its wide acceptance throughout the industry.

ORDERING INFORMATION				
Package	TO-220AB			
Lead (Pb)-free	IRF730PbF			
Lead (Pb)-free and halogen-free	IRF730PbF-BE3			

ABSOLUTE MAXIMUM RATINGS (T_{C}	= 25 C, uni	ess otherwis				
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			V _{DS}	400	- v	
Gate-source voltage			V _{GS}	± 20		
Continuous drain current	V _{GS} at 10 V	T _C = 25 °C	1-	5.5		
Continuous drain current	V_{GS} at 10 V $T_C = 100 \text{ °C}$	ID	3.5	А		
Pulsed drain current ^a			I _{DM}	22	1	
Linear derating factor			0.59	W/°C		
Single pulse avalanche energy ^b		E _{AS}	290	mJ		
Repetitive avalanche current ^a		I _{AR}	I _{AR} 5.5			
Repetitive avalanche energy ^a			E _{AR}	7.4	mJ	
Maximum power dissipation	T _C = 25 °C		PD	74	W	
Peak diode recovery dV/dt ^c			dV/dt	4.0	V/ns	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Soldering recommendations (peak temperature) ^d	For 10 s			300	7 0	
Mounting torque	6-32 or M3 screw			10	lbf ∙ in	
Mounting torque				1.1	N⋅m	

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. $V_{DD} = 50 \text{ V}$, starting $T_J = 25 \text{ °C}$, L = 16 mH, $R_g = 25 \Omega$, $I_{AS} = 5.5 \text{ A}$ (see fig. 12)

c. $I_{SD} \le 5.5$ A, dI/dt ≤ 90 A/µs, $V_{DD} \le V_{DS}$, $T_J \le 150$ °C

d. 1.6 mm from case

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum junction-to-ambient	R _{thJA}	-		62				
Case-to-sink, flat, greased surface	R _{thCS}	0.50 - 1.7			°C/W			
Maximum junction-to-case (drain)	R _{thJC}							
			1					
SPECIFICATIONS (T _J = 25 °C, u	Inless otherw	vise noted)						
PARAMETER	SYMBOL	1	CONDITIO	NS	MIN.	TYP.	MAX.	UNIT
Static						<u> </u>	I	I
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0$	0 V, I _D = 250	Ο μΑ	400	-	-	V
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	to 25 °C, I _D) = 1 mA	-	0.54	-	V/°C
Gate-source threshold voltage	V _{GS(th)}	$V_{DS} = V$	/ _{GS} , I _D = 250	0 μΑ	2.0	-	4.0	V
Gate-source leakage	I _{GSS}	Vo	_{3S} = ± 20 V		-	-	± 100	nA
		$V_{DS} = 4$	100 V, V _{GS} =	= 0 V	-	-	25	
Zero gate voltage drain current	IDSS	V _{DS} = 320 V, V	V _{GS} = 0 V, 7	「」= 125 °C	-	-	250	μA
Drain-source on-state resistance	R _{DS(on)}	V _{GS} = 10 V	I _D =	3.3 A ^b	-	-	1.0	Ω
Forward transconductance	9 _{fs}	V _{DS} = 5	60 V, I _D = 3.3	3 A ^b	2.9	-	-	S
Dynamic								
Input capacitance	C _{iss}	V _{GS} = 0 V,		-	700	-		
Output capacitance	C _{oss}	V	_{DS} = 25 V,		-	170	-	pF
Reverse transfer capacitance	C _{rss}	f = 1.0 MHz, see fig. 5		-	64	-		
Total gate charge	Qg				-	-	38	
Gate-source charge	Q _{gs}	$V_{GS} = 10 V$ $I_D = 3.5 A, V_{DS} = 320 V,$ see fig. 6 and 13 ^b		-	-	5.7	nC	
Gate-drain charge	Q _{gd}		see lig.		-	-	22	
Turn-on delay time	t _{d(on)}		•		-	10	-	
Rise time	t _r	- V _{DD} = 2	200 V, I _D = 3	3.5 A	-	15	-	ns
Turn-off delay time	t _{d(off)}	$R_g = 12 \Omega, R_f$			-	38	-	
Fall time	t _f	- ~ ·		-	14	-		
Gate input resistance	R _g	f = 1 MHz, open drain		0.6	-	2.3	Ω	
Internal drain inductance	L _D	Between lead, 6 mm (0.25") from package and center of die contact		-	4.5	-	nH	
Internal source inductance	L _S			-	7.5	-		
Drain-Source Body Diode Characteristic	cs							
Continuous source-drain diode current	١ _S	showing the		5.5				
Pulsed diode forward current ^a	I _{SM}			-	-	22	A	
Body diode voltage	V _{SD}	T _J = 25 °C, I	_S = 5.5 A, V	_{GS} = 0 V ^b	-	-	1.6	V
Body diode reverse recovery time	t _{rr}	T 05 %C 1		100 A/us b	-	270	530	ns
Body diode reverse recovery charge	Q _{rr}	– T _J = 25 °C, I _F =	3.5 A, ai/dt	= 100 A/µs ^o	-	1.8	2.2	μC
Forward turn-on time	t _{on}	Intrinsic turr	n-on time is	negligible (turn	-on is dor	ninated b	by L _S and	L _D)

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)

b. Pulse width \leq 300 $\mu s;$ duty cycle \leq 2 $\,\%$

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

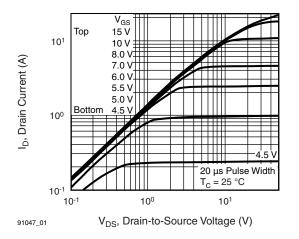


Fig. 1 - Typical Output Characteristics, T_C = 25 °C

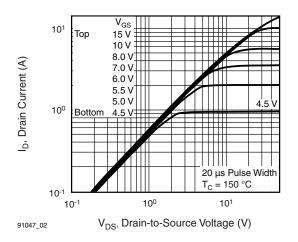
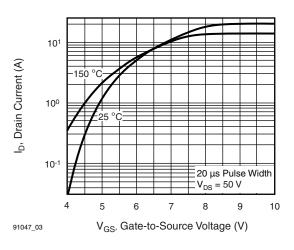


Fig. 2 - Typical Output Characteristics, T_C = 150 $^\circ C$





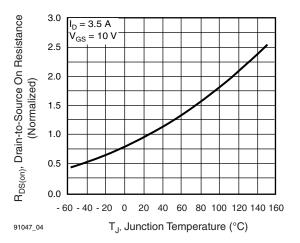


Fig. 4 - Normalized On-Resistance vs. Temperature

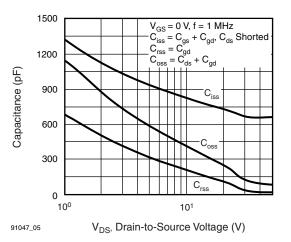
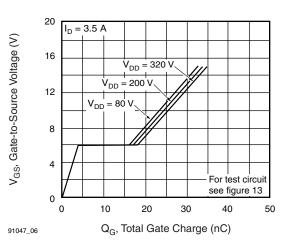


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage





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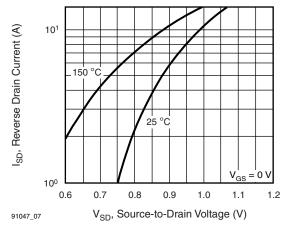


Fig. 7 - Typical Source-Drain Diode Forward Voltage

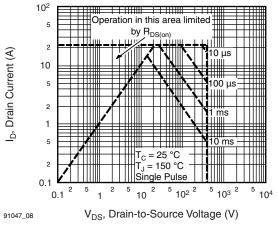


Fig. 8 - Maximum Safe Operating Area

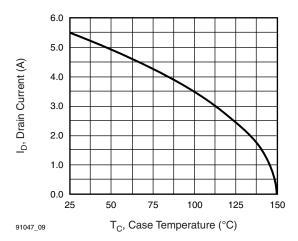


Fig. 9 - Maximum Drain Current vs. Case Temperature

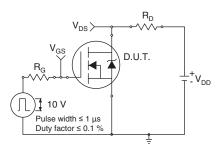


Fig. 10a - Switching Time Test Circuit

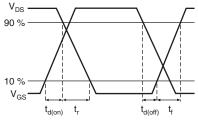
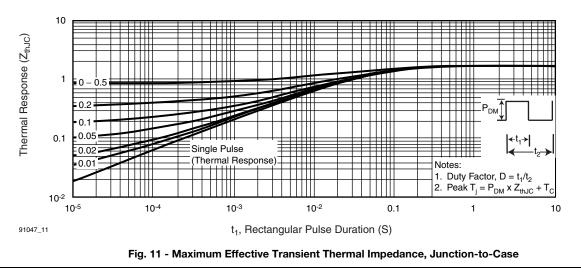


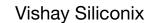
Fig. 10b - Switching Time Waveforms

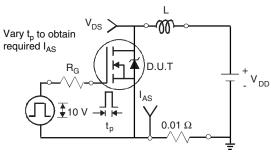


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Fig. 12a - Unclamped Inductive Test Circuit

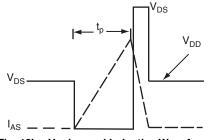


Fig. 12b - Unclamped Inductive Waveforms

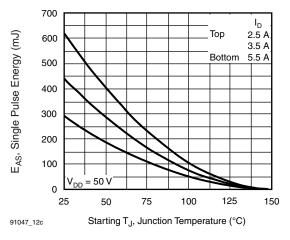


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

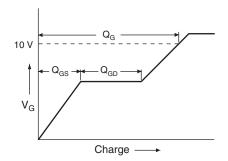


Fig. 13a - Basic Gate Charge Waveform

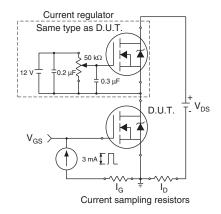


Fig. 13b - Gate Charge Test Circuit

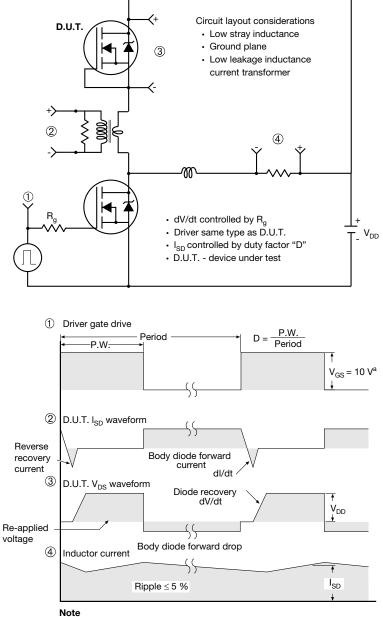
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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 14 - For N-Channel

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TO-220-1



DIM	MILLIN	METERS	INC	HES
DIM.	MIN.	MAX.	MIN.	MAX.
А	4.24	4.65	0.167	0.183
b	0.69	1.02	0.027	0.040
b(1)	1.14	1.78	0.045	0.070
С	0.36	0.61	0.014	0.024
D	14.33	15.85	0.564	0.624
E	9.96	10.52	0.392	0.414
е	2.41	2.67	0.095	0.105
e(1)	4.88	5.28	0.192	0.208
F	1.14	1.40	0.045	0.055
H(1)	6.10	6.71	0.240	0.264
J(1)	2.41	2.92	0.095	0.115
L	13.36	14.40	0.526	0.567
L(1)	3.33	4.04	0.131	0.159
ØP	3.53	3.94	0.139	0.155
Q	2.54	3.00	0.100	0.118

Note

• M* = 0.052 inches to 0.064 inches (dimension including protrusion), heatsink hole for HVM



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